



Contact:

Investor Relations
+86-21-3861-0000 ext. 12804
ir@smics.com

NEWS RELEASE

SMIC Reports 2014 Third Quarter Results

All currency figures stated in this report are in US Dollars unless stated otherwise.

The consolidated financial statements are prepared in accordance with International Financial

Shanghai, China November 5, 2014. Semiconductor Manufacturing International Corporation leading semiconductor foundries in the world, today announced its consolidated results of operations for the three months ended September 30, 2014.

Third Quarter 2014 Highlights

Revenue was \$521.6 million in 3Q14, an increase of 2.0% quarter over quarter.
Gross margin was 25.9% in 3Q14, compared to 28.0% in 2Q14 and 21.0% in 3Q13.
Profit for the period attributable to SMIC was \$47.5 million in 3Q14, compared to \$56.8 million in 2Q14 and \$42.5 million in 3Q13.

Fourth Quarter 2014 Guidance:

The following statements are forward looking statements which are based on current expectations

Revenue is expected to decrease by 5% to 9% quarter over quarter.
Gross margin is expected to range from 19.5% to 22.5%.
Non-GAAP operating expenses excluding the effect of employee bonus accrual, government funding and gain from the disposal of living quarters are expected to range from \$99 million to \$103 million.

Dr. Tzu- SMIC had a good quarter in Q3; we achieved our tenth consecutive profitable quarter. When excluding Wuhan Xinxin, we reached another record high revenue and grew 2.0% quarter over quarter and 3.6% year over year. Profit for the period attributable to SMIC was \$47.5 million.

In terms of expansion, we plan to expand our Tianjin fab s production capacity to 42,000 8-inch wafers per month and Shenzhen is on track to reach 10,000 wafers per month installed capacity by year-end. We target to expand the Shenzhen fab capacity to 20,000 wafers per month capacity by the

end of 2015. Meanwhile, the Beijing JV project is estimated to have 1,000 12-inch wafers per month installed capacity by year-end and 10,000 by the end of 2015. We target to reach 6,000 12-inch wafers per month 28nm capability by the end of 2014 in our Shanghai facility.

The strong IC demand in China is continuing to drive our growth. Revenue from China has continued to be over 40% of our total revenue in the past 5 quarters and accounts for more than 42% of our total revenue in Q3 2014. As the largest and most advanced foundry in China, we are looking forward to accelerated industry growth and, as we focus our direction and technology to capture market opportunities serving the demand of the China market; we believe the opportunities for continued growth will be plentiful.

Conference Call / Webcast Announcement

Date: November 6, 2014

Time: 8:30 a.m. Shanghai time

Dial-in numbers and pass code:

China	+86 400-120-3170	(Pass code: SMIC)
Hong Kong	+852 3051-2792	(Pass code: SMIC)
Taiwan	+886 2-7743-8419	(Pass code: SMIC)
United States, New York	+1 845-507-1610	(Pass code: SMIC)

The call will be webcast live with audio at http://www.smics.com/eng/investors/ir_presentations.php or <http://www.media-server.com/m/p/973q4rzt>.

An archived version of the webcast, along with an electronic copy of this news release will be available on the SMIC website for a period of 12 months following the webcast.

About SMIC

Semiconductor Manufacturing International Corporation ("SMIC"; NYSE: SMI; SEHK: 981) is one of the leading semiconductor foundries in the world and the largest and most advanced foundry in mainland China. SMIC provides integrated circuit (IC) foundry and technology services at 0.35-micron to 28-nanometer. Headquartered in Shanghai, China, SMIC has a 300mm wafer fabrication facility (fab) and a 200mm mega-fab in Shanghai; a 300mm mega-fab in Beijing with a joint-venture 300mm fab that is currently under construction; a 200mm fab in Tianjin; and a 200mm fab project under development in Shenzhen. SMIC also has marketing and customer service offices in the U.S., Europe, Japan, and Taiwan, and a representative office in Hong Kong.

For more information, please visit www.smics.com.

Safe Harbor Statements

(Under the Private Securities Litigation Reform Act of 1995)

This press release contains, in

-

1995. These forward-Fourth Quarter 2014
and the statements regarding our production capacity plans, industry growth and our opportunities for continued growth through focusing our direction and technology into specific markets are based on
and projections about future events. SMIC uses words like
, target and similar expressions to
identify forward-looking statements, although not all forward-looking statements contain these words.
These forward-looking statements involve significant risks, both known and unknown, uncertainties

operations to be materially different from those suggested by the forward-looking statements including, among others, risks associated with the global economic slowdown, orders or judgments from pending litigation, intensive intellectual property lawsuits in semiconductor industry and financial stability in end markets.

Exchange Commission (SEC), including its annual report on 20-F filed with the SEC on April 14, 2014, especially the consolidated financial statements, and such other documents that SMIC may file

current reports on Form 6-K. Other unknown or unpredictable factors also could have material
s future results, performance or achievements. In light of these risks, uncertainties, assumptions and factors, the forward-looking events discussed in this press release may not occur. You are cautioned not to place undue reliance on these forward-looking statements, which speak only as of the date stated, or if no date is stated, as of the date of this press release. Except as may be required by law, SMIC undertakes no obligation and does not intend to update any forward-looking statement, whether as a result of new information, future events or otherwise.

About Non-Generally Accepted Accounting Principles (Non-GAAP) Financial Measures

in this press release non-GAAP measures of operating results that are adjusted to exclude wafer

SMIC began gradually phasing out in 3Q13. There were no wafer shipments from Wuhan Xinxin from 1Q14 onwards. This earnings release includes non-GAAP revenue and non-GAAP operating expenses, which consists of total operating expenses as adjusted to exclude the effect of employee bonus accrual, government funding and gain from the disposal of living quarters. This earnings release also includes fourth quarter 2014 guidance for non-GAAP operating expenses. The presentation of non-GAAP financial measures is not intended to be considered in isolation or as a substitute for the financial information prepared and presented in accordance with IFRS.

SMIC believes that use of these non-

uses these non-GAAP financial measures to understand, manage and evaluate the Company's business and make financial and operational decisions.

The accompanying table has more information and reconciliations of each non-GAAP financial measure to its most directly comparable GAAP financial measure. A reconciliation of non-GAAP guidance measures to corresponding GAAP measures is not available on a forward-looking basis.



Summary of Third Quarter 2014 Operating Results

Amounts in US\$ thousands, except for EPS and operating data

	3Q14	2Q14	QoQ	3Q13	YoY
Revenue	521,646	511,344	2.0%	534,256	-2.4%
Cost of sales	(386,704)	(368,291)	5.0%	(422,274)	-8.4%
Gross profit	134,942	143,053	-5.7%	111,982	20.5%
Operating expenses	(94,122)	(84,861)	10.9%	(63,447)	48.3%
Profit from operations	40,820	58,192	-29.9%	48,535	-15.9%
Other income (expense), net	7,840	(1,105)	-	(4,681)	-
Profit before tax	48,660	57,087	-14.8%	43,854	11.0%
Income tax benefit (expense)	18	93	-80.6%	(914)	-
Profit for the period	48,678	57,180	-14.9%	42,940	13.4%
Other comprehensive income:					
Exchange differences on translating foreign operations	1,320	(858)	-	77	1614.3%
Total comprehensive income for the period	49,998	56,322	-11.2%	43,017	16.2%
Profit for the period attributable to:					
Attributable to SMIC	47,520	56,801	-16.3%	42,491	11.8%
Non-controlling interests	1,158	379	205.5%	449	157.9%
Profit for the period	48,678	57,180	-14.9%	42,940	13.4%
Gross margin	25.9%	28.0%	-	21.0%	-
Earnings per ordinary share ⁽¹⁾					
Basic	0.00	0.00		0.00	
Diluted	0.00	0.00		0.00	
Earnings per ADS ⁽²⁾					
Basic	0.07	0.09		0.07	
Diluted	0.07	0.08		0.07	
equivalent wafers)	668,811	648,764	3.1%	653,090	2.4%
Capacity utilization ⁽³⁾	91.9%	94.6%	-	88.2%	-

Note:

(1) Based on weighted average ordinary shares of 34,846 million (basic) and 38,904 million (diluted) in 3Q14, 32,766 million (basic) and 35,291 million (diluted) in 2Q14, and 32,084 million (basic) and 32,355 million (diluted) in 3Q13.

(2) Each ADS represents 50 ordinary shares.

(3) Based on total equivalent wafers out divided by estimated total quarterly capacity.

Revenue increased 2.0% QoQ from \$511.3 million in 2Q14 to \$521.6 million in 3Q14 mainly because of an increase in wafer shipments in 3Q14. Revenue decreased 2.4% YoY from \$534.3 million in 3Q13 mainly because there were no wafer shipments from Wuhan Xinxin since 1Q14.

Non-GAAP revenue excluding wafer shipments from Wuhan Xinxin was a record high of \$521.6 million in 3Q14, an increase of 3.6% YoY compared to \$503.7 million in 3Q13.

Cost of sales increased to \$386.7 million in 3Q14, up 5.0% QoQ from \$368.3 million in 2Q14.

Gross profit was \$134.9 million in 3Q14, a decrease of 5.7% QoQ from \$143.1 million in 2Q14.

Gross margin was 25.9% in 3Q14, down from 28.0% in 2Q14, primarily due to a decrease in fab utilization.

Operating expenses increased to \$94.1 million in 3Q14, an increase of 10.9% QoQ from \$84.9 million in 2Q14, mainly due to the reasons stated in Operating Expenses (Income) Analysis below.

Analysis of Revenue

Revenue Analysis			
By Application	3Q14	2Q14	3Q13
Computer	2.3%	2.8%	1.8%
Communications	44.6%	41.4%	44.4%
Consumer	44.3%	48.0%	43.9%
Others	8.8%	7.8%	9.9%
By Service Type	3Q14	2Q14	3Q13
Wafers	94.6%	95.4%	93.8%
Mask making, testing, others	5.4%	4.6%	6.2%
By Customer Type	3Q14	2Q14	3Q13
Fabless semiconductor companies	86.8%	85.2%	87.7%
Integrated device manufacturers (IDM)	3.3%	3.0%	5.5%
System companies and others	9.9%	11.8%	6.8%
By Geography	3Q14	2Q14	3Q13
North America	43.7%	42.0%	46.0%
China ⁽¹⁾	42.2%	44.4%	42.1%
Eurasia ⁽²⁾	14.1%	13.6%	11.9%
Wafer Revenue Analysis			
By Technology	3Q14	2Q14	3Q13
40/45 nm	10.4%	13.2%	15.7%
55/65 nm	24.3%	26.3%	27.1%
90 nm	3.5%	3.4%	4.7%
0.13 μm	11.5%	12.1%	10.1%
0.15/0.18 μm	45.7%	40.2%	38.4%
0.25/0.35 μm	4.6%	4.8%	4.0%

Note:

(1) Including Hong Kong, but excluding Taiwan

(2) Excluding China

Capacity*

Fab / (Wafer Size)	3Q14	2Q14
	96,000	96,000
Shanghai 12-	31,500	31,500
Beijing Mega Fab (12")	81,000	81,000
Tianjin Fab (8")	39,000	39,000
Total monthly wafer fabrication capacity	247,500	247,500

Note:

*

ers, calculated on a 30-day basis for comparison purposes

Monthly capacity was 247,500 8-inch equivalent wafers in 3Q14, which was the same as 2Q14.

Shipment and Utilization

	3Q14	2Q14	QoQ	3Q13	YoY
Wafer shipments	668,811	648,764	3.1%	653,090	2.4%
Utilization rate ⁽¹⁾	91.9%	94.6%	-	88.2%	-

Note:

(1) Based on total equivalent wafers out divided by estimated total quarterly capacity.

Detailed Financial Analysis

Gross Profit Analysis

Amounts in US\$ thousands

	3Q14	2Q1
--	------	-----

Operating Expenses (Income) Analysis

Amounts in US\$ thousands	3Q14	2Q14	QoQ	3Q13	YoY
Operating expenses	94,122	84,861	10.9%	63,447	48.3%
Research and development	54,887	45,080	21.8%	37,564	46.1%
General and administrative	34,668	35,528	-2.4%	24,718	40.3%
Selling and marketing	10,090	9,018	11.9%	9,324	8.2%
Other operating income	(5,523)	(4,765)	15.9%	(8,159)	-32.3%

R&D expenses increased to \$54.9 million in 3Q14, compared to \$45.1 million in 2Q14. The increase

Liquidity

<i>Amounts in US\$ thousands</i>	3Q14	2Q14
Cash and cash equivalent	362,239	573,332
Restricted cash	159,118	181,573
Other financial assets	336,793	358,417
Trade and other receivables	490,910	458,765
Prepayment and prepaid operating expenses	43,736	42,261
Inventories	315,364	319,089
Assets classified as held-for-sale	578	1,543
Total current assets	1,708,738	1,934,980
Current tax liabilities	157	246
Accrued liabilities		

Cash Flow

<i>Amounts in US\$ thousands</i>	3Q14	2Q14
Net cash from operating activities	134,210	118,635
Net cash used in investing activities	(144,006)	(339,761)

Recent Highlights and Announcements

SMIC and ASML sign a Volume Purchase Agreement worth 450 million Euros (2014-10-27)
SMIC and Maxscend Collaborate on 55nm RF IP Platform (2014-10-23)
Notification of Board Meeting (2014-10-21)
Circulars - Notification Letter and Request Form to Non-registered Shareholders (2014-10-17)
Circulars - Notification Letter to Registered Shareholders (2014-10-17)
Closure of Register of Members (2014-10-17)
Notice of Extraordinary General Meeting (2014-10-17)
Proxy Forms - Form of Proxy for Use at the Extraordinary General Meeting to be Held on 5 November 2014 (2014-10-17)
Circulars - Non-exempt Connected Transactions (1) Pre-emptive Subscriptions by Datang and Country Hill (2) Proposed Pre-emptive Specific Mandates (3) Datang Supplemental Agreement (4) Notice of Extraordinary General Meeting (2014-10-17)
Overseas Regulatory Announcement (2014-10-08)
Completion of the Issue of US\$500 Million 4.125% Bonds Due 2019 (2014-10-07)
-09-29)
Proposed Issue of US\$500 Million 4.125% Bonds Due 2019 (2014-09-26)
2014 SMIC Technology Symposium Will Kick Off in Shanghai (2014-09-18)
Proposed Issue of Bonds (2014-09-17)
Circulars - Notification Letter and Request Form to Non-registered Holders (2014-09-10)
Circulars - Notification Letter and Change Request Form to Registered Holders (2014-09-10)
Circulars - Letter and Reply Form to New Registered Shareholder - Election of Means of Receipt and Language of Corporate Communication (2014-09-10)

Semiconductor Manufacturing International Corporation
CONDENSED CONSOLIDATED STATEMENTS OF PROFIT OR LOSS AND OTHER COMPREHENSIVE INCOME
(In US\$ thousands except share data)

	For the three months ended	
	September 30, 2014 (Unaudited)	June 30, 2014 (Unaudited)
Revenue	521,646	511,344
Cost of sales	(386,704)	(368,291)
Gross profit	134,942	143,053
Research and development expenses	(54,887)	(45,080)
General and administration expenses	(34,668)	(35,528)
Sales and marketing expenses	(10,090)	(9,018)
Other operating income	5,523	4,765
Operating expenses	(94,122)	(84,861)
Profit from operation	40,820	58,192
Other income (expense), net	7,840	(1,105)
Profit before tax	48,660	57,087
Income tax benefit	18	93
Profit for the period	48,678	57,180
Other comprehensive income		
<i>Item that may be reclassified subsequently to profit or loss</i>		
Exchange differences on translating foreign operations	1,320	(858)
Total comprehensive income for the period	49,998	56,322
Profit for the period attributable to:		

Semiconductor Manufacturing International Corporation
CONDENSED CONSOLIDATED STATEMENTS OF PROFIT OR LOSS AND OTHER COMPREHENSIVE INCOME
(In US\$ thousands)

2013 that it had ceased to manage and operate the 300mm wafer fab in Wuhan owned by Wuhan Xinxin, and began gradually phasing out wafer shipments from Wuhan Xinxin in 3Q13. There were no wafer shipments from Wuhan Xinxin from 1Q14 onwards. However, the use of non-GAAP financial measures has material limitations as an analytical tool. One of the limitations of using non-GAAP financial measures is that they do not include all items that impact our net profit for the period. In addition, because non-GAAP financial measures are not calculated in the same manner by all companies, they may not be comparable to other similar titled measures used by other companies. In light of the foregoing limitations, you should not consider non-GAAP financial measure in isolation from or as an alternative to revenue and operating expenses prepared in accordance with IFRS.

The following table sets forth the reconciliation of each of non-GAAP revenue and non-GAAP operating expenses to its most directly comparable financial measure presented in accordance with IFRS, for the periods indicated.

	For the three months ended		
	September 30, 2014	June 30, 2014	September 30, 2013
	(Unaudited)	(Unaudited)	(Unaudited)
Revenue	521,646	511,344	534,256
Revenue from Wuhan Xinxin	-	-	(30,587)
Non-GAAP revenue	<u>521,646</u>	<u>511,344</u>	<u>503,669</u>
	For the three months ended		
	September 30, 2014	June 30, 2014	September 30, 2013
	(Unaudited)	(Unaudited)	(Unaudited)
Operating expenses	(94,122)	(84,861)	(63,447)
Employee bonus accrual	7,336	10,849	4,133
Government funding	(6,608)	(8,494)	(10,540)
Gain from the disposal of living quarters	(4,872)	(4,094)	(8,031)
Non-GAAP operating expenses	<u>(98,266)</u>	<u>(86,600)</u>	<u>(77,885)</u>

Semiconductor Manufacturing International Corporation
CONDENSED CONSOLIDATED STATEMENTS OF FINANCIAL POSITION
(In US\$ thousands)

	As of	
	September 30, 2014 (Unaudited)	June 30, 2014 (Unaudited)
ASSETS		
<i>Non-current assets</i>		
Property, plant and equipment	2,646,870	2,515,105
Prepaid land use right	136,000	136,623
Intangible assets	210,699	198,952
Investments in associates	31,433	30,820
Deferred tax assets	44,275	44,161
Other assets	9,918	7,228
Total non-current assets	<u>3,079,195</u>	<u>2,932,889</u>
<i>Current assets</i>		
Inventories	315,364	319,089
Prepayment and prepaid operating expenses	43,736	42,261
Trade and other receivables	490,910	458,765
Other financial assets	336,793	358,417
Restricted cash	159,118	181,573
Cash and cash equivalent	362,239	573,332
	<u>1,708,160</u>	<u>1,933,437</u>
Assets classified as held-for-sale	578	1,543
Total current assets	<u>1,708,738</u>	<u>1,934,980</u>
TOTAL ASSETS	<u>4,787,933</u>	<u>4,867,869</u>
EQUITY AND LIABILITIES		
<i>Capital and reserves</i>		
Ordinary shares, \$0.0004 par value, 50,000,000,000 shares authorized, 34,883,181,261 and 34,831,860,338 shares issued and outstanding at September 30, 2014 and June 30, 2014, respectively	13,953	13,933
Share premium	4,301,268	4,296,190
Reserves	88,954	87,004
Accumulated deficit	(1,569,277)	(1,616,797)
Equity attributable to owners of the Company	<u>2,834,898</u>	<u>2,780,330</u>
Non-controlling interests	109,872	108,715
Total equity	<u>2,944,770</u>	<u>2,889,045</u>
<i>Non-current liabilities</i>		
Borrowings	217,000	430,520
Convertible bonds	355,362	352,317
Deferred tax liabilities	122	122
Deferred government funding	190,691	192,325
Total non-current liabilities	<u>763,175</u>	<u>975,284</u>
<i>Current liabilities</i>		
Trade and other payables	531,334	474,268
Borrowings	376,978	365,269
Deferred government funding	53,563	31,484
Accrued liabilities	117,956	132,273
Current tax liabilities	157	246
Total current liabilities	<u>1,079,988</u>	<u>1,003,540</u>
Total liabilities	<u>1,843,163</u>	<u>1,978,824</u>
TOTAL EQUITY AND LIABILITIES	<u>4,787,933</u>	<u>4,867,869</u>

Semiconductor Manufacturing International Corporation
CONDENSED CONSOLIDATED STATEMENT OF CASH FLOWS
(In \$US thousands)

	For the three months ended	
	September 30, 2014	June 30, 2014
	(Unaudited)	(Unaudited)
Cash flow from operating activities		
Profit for the period	48,678	57,180
Depreciation and amortization	138,889	138,463
Share of profits of associates	(309)	(566)
Changes in working capital and others	(53,048)	(76,442)
Net cash from operating activities	134,210	118,635
Cash flow from investing activities:		
Payments for property, plant and equipment	(212,317)	(108,683)
Payments for intangible assets	(14,682)	(9,948)
Proceeds from disposal of property, plant and equipment	9,526	2,654
Changes in restricted cash relating to investing activities	54,418	(43,749)
Payments to acquire financial assets	(434,075)	(443,617)
Proceeds on sale of financial assets	455,712	263,582
Payment to acquire long-term equity investment	(2,588)	-
Net cash used in investing activities	(144,006)	(339,761)
Cash flow from financing activities:		
Proceeds from borrowings	96,314	99,514
Repayment of borrowings	T/F2 9 Tf 36]TJETQq35.4 356.2 TJETQq374.47 373	